

Date: 19 August 2020

研祥高科技控股集團有限公司

EVOC Hi-Tech Holding Group Co., Ltd* (the “Offeror”)

B1, 20/F

EVOC Technology Building

No. 31 Gaoxinhongsi Road

Nanshan District, Shenzhen

People’s Republic of China

Attn: Board of Directors

研祥智能科技股份有限公司

EVOC Intelligent Technology Company Limited* (the “Company”)

Unit No. 1619,

16th Floor, Star House

3 Salisbury Road,

Tsimshatsui, Kowloon

Hong Kong

Attn: Board of Directors

Dear Sirs

Composite document relating to (1) voluntary conditional offer by ICBC International Capital Limited for and on behalf of the Offeror to acquire all the issued H shares of EVOC Intelligent Technology Company Limited and (2) proposed voluntary withdrawal of listing of the H Shares of EVOC Intelligent Technology Company Limited (the “H Share Offer”)

We refer to the composite document dated 19 August 2020 to be jointly issued by the Offeror and the Company in connection with the H Share Offer (the “**Composite Document**”). Capitalised terms used in this letter shall have the same meanings as those defined in the Composite Document unless otherwise defined.

We hereby give our consent, and confirm that we have not withdrawn our written consent to the issue of the Composite Document with the inclusion therein of our opinions, reports, advice, recommendations, and/or letters (as the case may be) and the references to our name, logo, opinions, reports, advice, recommendations, and/or letters in the form and context in which they are included.

We also consent to this letter and documents mentioned herein being made available for inspection.

Yours faithfully

For and on behalf of

ICBC International Capital Limited



Name: Ng Chi Fai

Title: Managing Director, M&A Advisory Group

Yours faithfully

For and on behalf of

ICBC International Capital Limited



Name: Wu Lap Yee Letty

Title: Executive Director, Corporate Advisory Group

**For identification purpose only*